BF720T1G, SBF720T1G, **BF720T3G**

NPN Silicon Transistor

Features

- AEC-Q101 Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant*



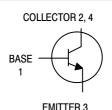
ON Semiconductor®

http://onsemi.com

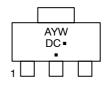
NPN SILICON TRANSISTOR SURFACE MOUNT



SOT-223 (TO-261) **CASE 318E** STYLE 1



MARKING DIAGRAM



А = Assembly Location Y

- w = Work Week
- DC = Device Code
 - = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
BF720T1G	SOT-223 (Pb-Free)	1,000 / Tape & Reel
SBF720T1G	SOT-223 (Pb-Free)	1,000 / Tape & Reel
BF720T3G	SOT-223 (Pb-Free)	4,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V _{CEO}	300	Vdc
Collector – Base Voltage	V _{CBO}	300	Vdc
Collector – Emitter Voltage	V _{CER}	300	Vdc
Emitter-Base Voltage	V _{EBO}	5.0	Vdc
Collector Current	Ι _C	100	mAdc
Total Power Dissipation up to $T_A = 25^{\circ}C$	PD	1.5	W
Storage Temperature Range	T _{stg}	-65 to +150	°C
Junction Temperature	TJ	150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance,	_		°C/W
Junction-to-Ambient (Note 1)	$R_{ heta JA}$	83.3	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Device mounted on a glass epoxy printed circuit board 1.575 in. x 1.575 in. x 0.059 in.; mounting pad for the collector lead min. 0.93 in².

*For additional information on our Pb-Free strategy and soldering details, please

download the ON Semiconductor Soldering and Mounting Techniques

Reference Manual, SOLDERRM/D.

⁼ Year

BF720T1G, SBF720T1G, BF720T3G

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristics	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage $(I_{C} = 1.0 \text{ mAdc}, I_{B} = 0)$	V _{(BR)CEO}	300	_	Vdc
Collector-Base Breakdown Voltage $(I_C = 100 \ \mu Adc, I_E = 0)$	V _{(BR)CBO}	300	_	Vdc
Collector-Emitter Breakdown Voltage ($I_C = 100 \ \mu Adc, R_{BE} = 2.7 \ k\Omega$)	V _{(BR)CER}	300	_	Vdc
Emitter-Base Breakdown Voltage $(I_E = 10 \ \mu Adc, I_C = 0)$	V _{(BR)EBO}	5.0	_	Vdc
Collector-Base Cutoff Current $(V_{CB} = 200 \text{ Vdc}, I_E = 0)$	Ісво	_	10	nAdc
	I _{CER}	-	50 10	nAdc μAdc
ON CHARACTERISTICS				
DC Current Gain (I _C = 25 mAdc, V _{CE} = 20 Vdc)	h _{FE}	50	_	-
Collector-Emitter Saturation Voltage $(I_C = 30 \text{ mAdc}, I_B = 5.0 \text{ mAdc})$	V _{CE(sat)}	-	0.6	Vdc
DYNAMIC CHARACTERISTICS				
Current–Gain – Bandwidth Product (I _C = 10 mAdc, V _{CE} = 10 Vdc, f = 35 MHz)	f _T	60	-	MHz
Feedback Capacitance $(V_{CE} = 30 \text{ Vdc}, I_C = 0, f = 1.0 \text{ MHz})$	C _{re}	_	1.6	pF

BF720T1G, SBF720T1G, BF720T3G

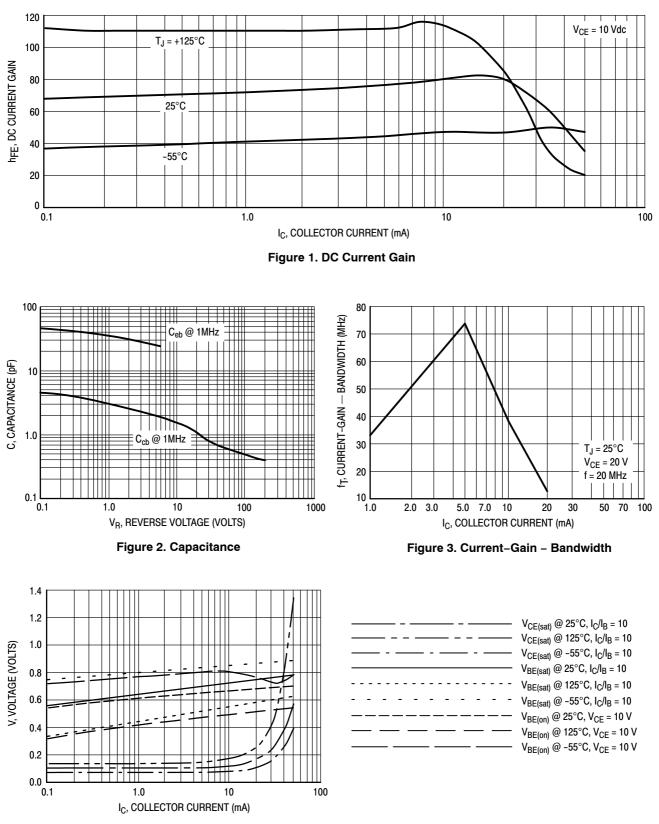
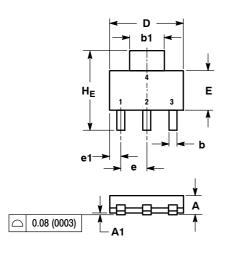


Figure 4. "ON" Voltages

PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 **ISSUE N**



С

NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: INCH.

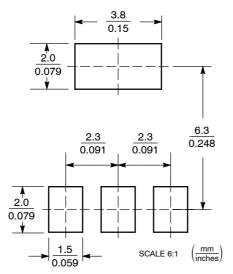
MILLIMETERS INCHES DIN NOM MAX NOM MIN MIN MAX Α 1.50 1.63 1.75 0.060 0.064 0.068 A1 0.02 0.06 0.10 0.001 0.002 0.004 b 0.60 0.75 0.89 0.024 0.030 0.035 b1 2.90 3.06 3.20 0.115 0.121 0.126 0.24 0.29 0.35 0.009 0.012 0.014 С D 6 30 6.50 6.70 0 249 0 256 0 263 Е 3.30 3.50 3.70 0.130 0.138 0.145 2.30 0.087 0.091 0.094 2.40 е 2.20 0.85 0.94 1.05 0.033 0.037 0.041 e1 0.20 0.008 L L1 1.75 2.00 0.069 0.078 1.50 0.060 ΗE 6.70 7.00 7.30 0.264 0.276 0.287 θ 0 10 10°

0



3. 4. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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